

# A product Line of Diodes Incorporated

US Series Quartz Crystal 1.6 x 1.2 x 0.4mm Max.

# **Miniature Quartz Crystal Ceramic SMD**





1.6 x 1.2mm Ceramic SMD

# **Product Description**

The 4-pad US Series seam seal devices incorporate a ultra-miniature AT-cut crystal resonator housed in a standard 1.6 x 1.2mm ceramic package. These compact crystals are ideal for surface mounting in densely populated or small form-factor PCB applications.

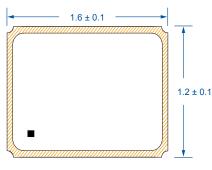
# **Product Features**

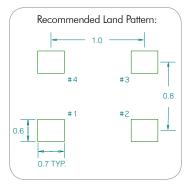
- Rugged AT-cut crystal construction
- Miniature 1.6 x 1.2mm ceramic package
- Available on tape & reel; 8mm tape, 3000 units per reel
- Pb-free and RoHS/Green compliant

# **Typical Applications**

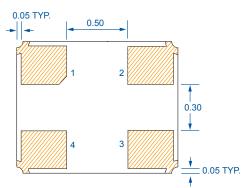
- Smart Phone
- Portable / Hand-held PCs
- PCMCIA Cards
- Notebook PC
- Bluetooth
- Wireless LAN
- SIP
- RF-SIM
- Pin Drive
- SD Module

# Package: (Scale: none; Dimensions are in mm)





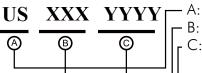


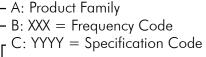


# **Pin Functions:**

Pin	Function
1	Xtal
2	Case
3	Xtal
4	Case

### **Part Ordering Information:**





Following the above format, Saronix-eCera part numbers will be assigned upon confirmation of exact customer requirements.



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# **Frequency Range:**

• 24.000000 MHz to 66.000000 MHz (Fundamental)

# Characteristics at 25°C ±2°C:

- Frequency Calibration Tolerance:  $\pm 10$  ppm, to  $\pm 50$  ppm
- Load Capacitance: 8 to 20pF or Series Resonance
- Equivalent Series Resistance (ESR):

 $100\Omega \max (24.000000 \text{ to } 40.000000 \text{ MHz})$ 

80Ω max (40.000001 to 66.000000 MHz)

- Drive Level: 10µW typ. (100µW max)
- Shunt Capacitance: 3pF Max

#### **Temperature Range:**

- Operating: -20°C to +70°C or -30°C to +85°C or -40°C to +125°C
- Storage:  $-40^{\circ}C$  to  $+125^{\circ}C$

#### Frequency Stability (Reference to the Frequency at 25°C):

- –20°C to +70°C:  $\pm$ 10ppm, to  $\pm$ 50ppm
- •–30°C to +85°C:  $\pm$ 20ppm, to  $\pm$ 50ppm
- •–40°C to +125°C:  $\pm$ 50ppm, to  $\pm$ 70ppm

### Aging at 25°C, First Year:

- •±3ppm Max
- •±5ppm Max

#### **Reflow Temperature:**

•260°C Max, 10 seconds Max

#### Mechanical

- •Shock: JESD22-B104 Condition B
- •Solderability: J-STD-002
- Vibration: JESD22-B103
- •Solvent Resistance: JESD22-B107
- Resistance to Soldering Heat: J-STD-020C Table 5-2 Pb-free devices (3 cycles max)

#### Environmental

- •Gross Test Leak: JESD22-A109, Condition C
- Fine Test Leak: JESD22-A109, Condition A1
- •Moisture Resistance: JESD22-A113
- Insulation Resistance: 500 MΩ min (100 VDC)